TYPES 2N1038, 2N1039, 2N1040, 2N1041

P-N-P ALLOY-JUNCTION GERMANIUM MEDIUM-POWER TRANSISTORS



40, 60, 80, 100 VOLT UNITS

1.25 Watts at 25°C Ambient

Guaranteed Beta at 50 ma and 1 amp

Low R cs · Low I co · Low V BE

ROUND WELDED PACKAGE

RELAY DRIVERS • PULSE AMPLIFIERS • AUDIO AMPLIFIERS
HIGH CURRENT SWITCHING CIRCUITS



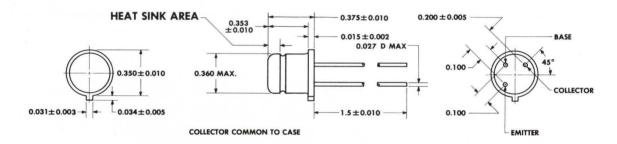
ACTUAL SIZE

qualification testing

To assure maximum reliability, stability, and long life, all units are leak tested and heat cycled from -55° C to 95° C for four complete cycles over an eight-hour period. All transistors are tested for rigid adherence to specified design characteristics.

mechanical data

The transistor is encapsulated with glass-to-metal seals and a projection welded case. Any effective heat radiator can be clamped to the heat sink area, indicated in the outline drawing, due to the low thermal resistance from the collector junction to case. The approximate weight of the unit is 1.9 grams.



maximum ratings at 25°C*

		2N1038	2N1039	2N1040	2N1041	Units
V _{CBO}	Collector-to-Base Voltage ($I_C = -750 \mu a$) ($I_E = 0$)	-40	-60	-80	-100	v
VCEX	Collector-to-Emitter Voltage ($V_{BE} = +0.2 \text{ v}, I_C = -750 \mu a$)	-40	-60	-80	-100	v
V_{EBO}	Emitter-to-Base Voltage $(I_E = -750 \mu a) (I_C = 0)$	-20	-20	—20	-20	v
	Total Dissipation at 25°C*	20	20	20	20	w
	Total Dissipation at 75°C*	5.7	5.7	5.7	5.7	w
1 _C	Collector Current	-3	-3	-3	-3	a
I _B	Base Current	-1	-1	-1	-1	a
TJ	Junction Temperature	95	95	95	95	°C

typical characteristics at 25°C*

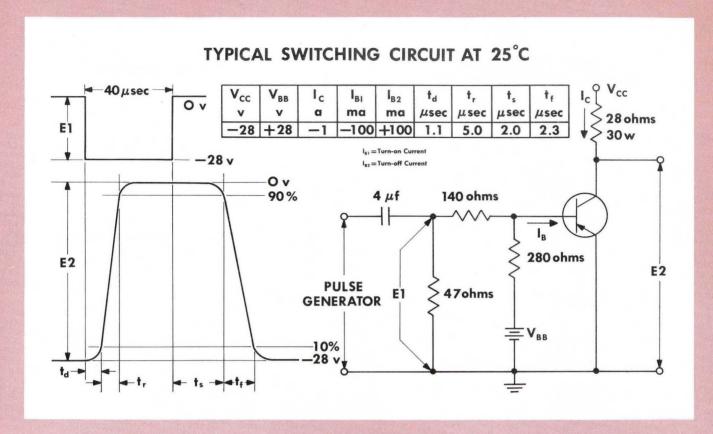
BV _{CBO}	Collector-to-Base Breakdown Voltage ($I_C = -750 \mu a$, $I_E = 0$)		— 55	— 75	—95	-115	v
hFE	Forward Current Transfer Ratio† $(I_C = -1 \text{ amps}, V_{CE} = -0.5 \text{ v})$		35	35	35	35	
Rcs	Common-Emitter Saturation Resistance ($I_C = -1$ amp, $I_B = -100$ ma)	1	0.2	0.2	0.2	0.2	ohms

^{*} Temperature measured on heat sink area. See derating curve for operation at higher temperatures.

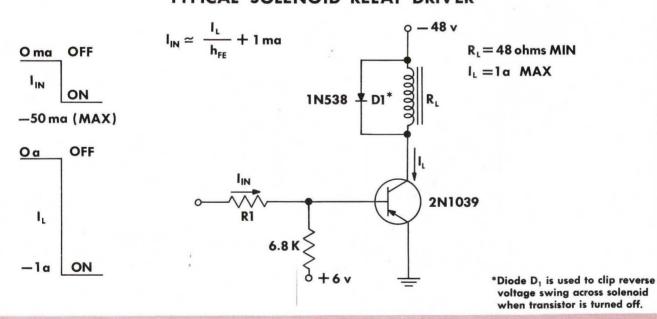
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LICENSED UNDER BELL SYSTEM PATENTS

 $[\]dagger$ $\,h_{FE}$ is maintained within 3:1 spread (h $_{FE}=20$ to 60 at I $_{C}=1$ amp, V $_{CE}=-0.5$ v).





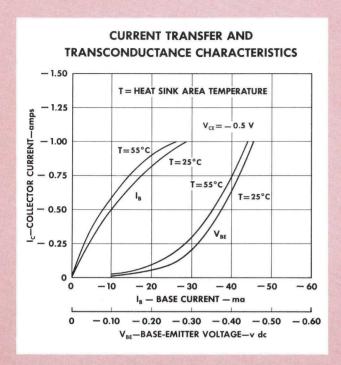


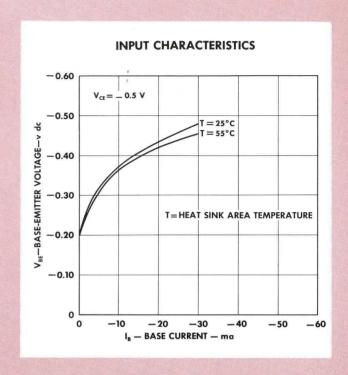
Texas Instruments

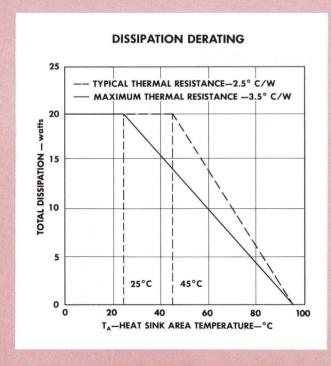
INCORPORATED

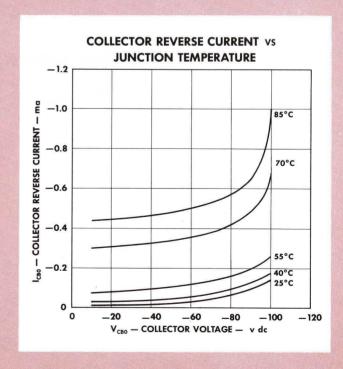
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TYPICAL CHARACTERISTICS









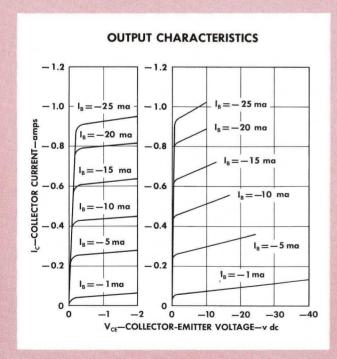
TYPES 2N1038, 2N1039, 2N1040, 2N1041

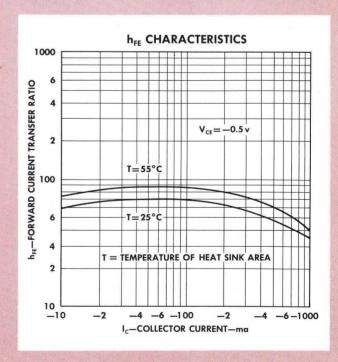
TYPICAL CHARACTERISTICS

design characteristics at 25°C

type	symbol	parameter	test conditions	min.	design center	max.	unit
2N1038	BV _{CBO}	Collector-to-Base Breakdown Voltage	$I_{C} = -750 \mu a, I_{E} = 0$	-40		_	٧
2N1039	BV _{CBO}	Collector-to-Base Breakdown Voltage	$I_{C} = -750 \mu a, I_{E} = 0$	60	_	_	V
2N1040	BV _{CBO}	Collector-to-Base Breakdown Voltage	$I_{C} = -750 \mu a, I_{E} = 0$	-80	- 1	e do s	٧
2N1041	BV _{CBO}	Collector-to-Base Breakdown Voltage	$I_{C} = -750 \mu a, I_{E} = 0$	-100	_	_	٧
All	BV _{EBO}	Emitter-to-Base Breakdown Voltage	$I_{E} = -750 \mu a, I_{C} = 0$	-20	-	_	V
All	I _{CBO}	Collector Reverse Current	$V_{CB} = \frac{1}{2}BV_{CBO}$ Min, $I_E = 0$		—50	-125	μa
All	I _{EBO}	Emitter Reverse Current	$V_{EB} = -10v, I_{C} = 0$	_	-50	_	μa
All	I _B	Base Current	$I_{C} = -1a, V_{CE} = -0.5v$	-16.7	-30	-50	mà
All	I _B	Base Current	$I_{C} = -50 \text{ma}, V_{CE} = -0.5 \text{v}$	-0.5	-0.75	-1.5	ma
All	VBE	Base Voltage	$I_{C} = -1a, V_{CE} = -0.5v$	_	-0.45	-1.0	V
All	V _{BE}	Base Voltage	$I_{C} = -50 \text{ma}, V_{CE} = -0.5 \text{v}$	_	-0.2	-0.35	٧
All	V _{CE} (Sat.)	Saturation Voltage	$I_{C} = -1.a, I_{B} = -100 \text{m a}$	_	-0.2	-0.25	٧
All	Cob	Collector-to-Base Capacity	$V_{CB} = -6v, I_E = 0$	Silverin.	100	_	$\mu\mu$ f
All	$f_{lpha e}$	Common-Emitter Current Transfer Ratio Cutoff Frequency	$V_{CE}=-1.5v$, $I_{C}=-500$ ma	-	8.5	_	kc

TYPICAL CHARACTERISTICS — COMMON EMITTER





Texas Instruments